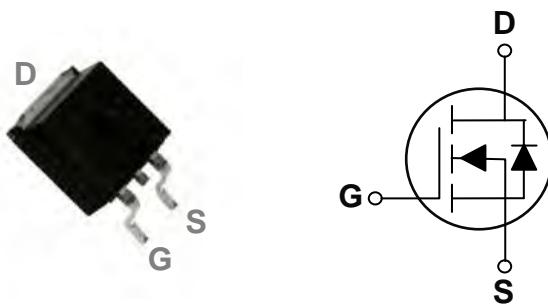


## 30V N-Channel MOSFETs

## General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

## TO-263 Pin Configuration



BVDSS	RDS(ON)	ID
30V	3mΩ	176A

## Features

- 30V, 176A, RDS(ON) = 3mΩ @ VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

## Applications

- MB / VGA / Vcore
- POL Applications
- SMPS 2<sup>nd</sup> SR

Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	176	A
$I_D$	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	111	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	704	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	180	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	60	A
$P_D$	Power Dissipation ( $T_c=25^\circ\text{C}$ )	168	W
$P_D$	Power Dissipation – Derate above 25°C	1.34	W/°C
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	0.74	°C/W



# FTK3960DD

## 30V N-Channel MOSFETs

Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

### Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	30	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$\text{BV}_{\text{DSS}}$ Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_D=1\text{mA}$	---	0.03	---	$\text{V}/^\circ\text{C}$
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=24\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	10	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA

### On Characteristics

$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance <sup>3</sup>	$V_{\text{GS}}=10\text{V}$ , $I_D=30\text{A}$	---	2.4	3	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_D=15\text{A}$	---	3.2	4	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D = 250\mu\text{A}$	1.2	1.6	2.5	V
$\Delta V_{\text{GS(th)}}$	$V_{\text{GS(th)}}$ Temperature Coefficient		---	-5	---	$\text{mV}/^\circ\text{C}$
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_D=2\text{A}$	---	16	---	S

### Dynamic Characteristics

$Q_g$	Total Gate Charge <sup>3, 4</sup>	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=4.5\text{V}$ , $I_D=24\text{A}$	---	40	75	nC
$Q_{\text{gs}}$	Gate-Source Charge <sup>3, 4</sup>		---	6	12	
$Q_{\text{gd}}$	Gate-Drain Charge <sup>3, 4</sup>		---	19	35	
$T_{\text{d(on)}}$	Turn-On Delay Time <sup>3, 4</sup>	$V_{\text{DD}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_G=1\Omega$	---	20	40	ns
$T_r$	Rise Time <sup>3, 4</sup>		---	32	60	
$T_{\text{d(off)}}$	Turn-Off Delay Time <sup>3, 4</sup>		---	75	130	
$T_f$	Fall Time <sup>3, 4</sup>		---	28	55	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	4800	8000	pF
$C_{\text{oss}}$	Output Capacitance		---	735	1300	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	420	800	
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $F=1\text{MHz}$	---	1.6	3.5	$\Omega$

### Drain-Source Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	176	A
			---	---	352	A
$V_{\text{SD}}$	Diode Forward Voltage <sup>3</sup>	$V_{\text{GS}}=0\text{V}$ , $I_s=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1	V
			---	49	85	ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$T_J=25^\circ\text{C}$	---	18	35	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{\text{DD}}=25\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{\text{AS}}=60\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
3. The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.

## 30V N-Channel MOSFETs

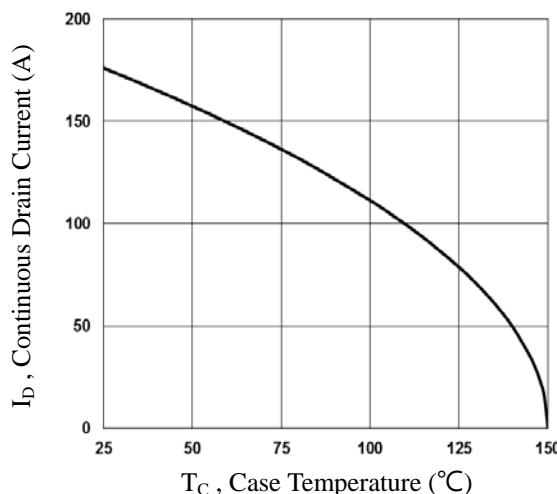


Fig.1 Continuous Drain Current vs. T<sub>C</sub>

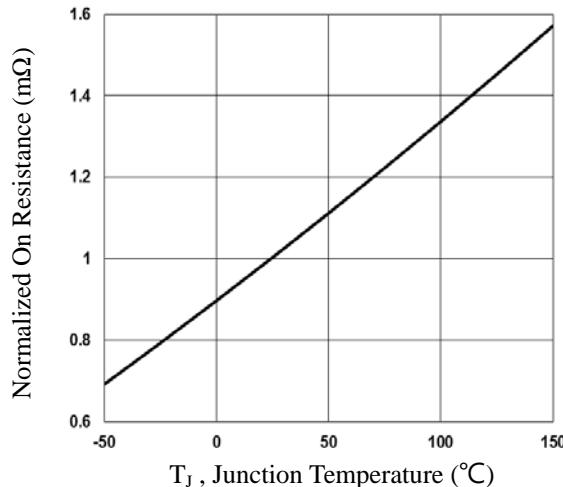


Fig.2 Normalized RDS(on) vs. T<sub>J</sub>

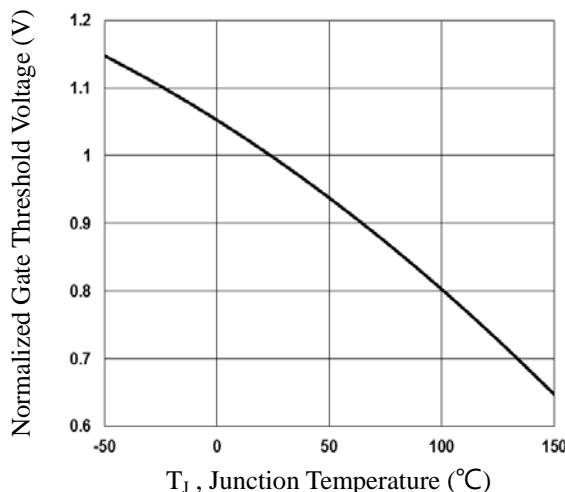


Fig.3 Normalized V<sub>th</sub> vs. T<sub>J</sub>

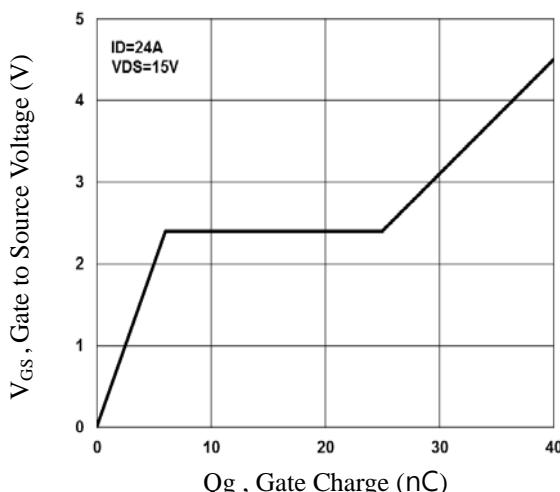


Fig.4 Gate Charge Waveform

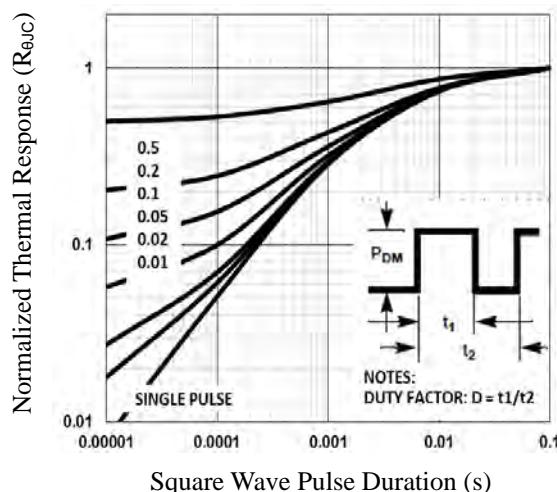


Fig.5 Normalized Transient Impedance

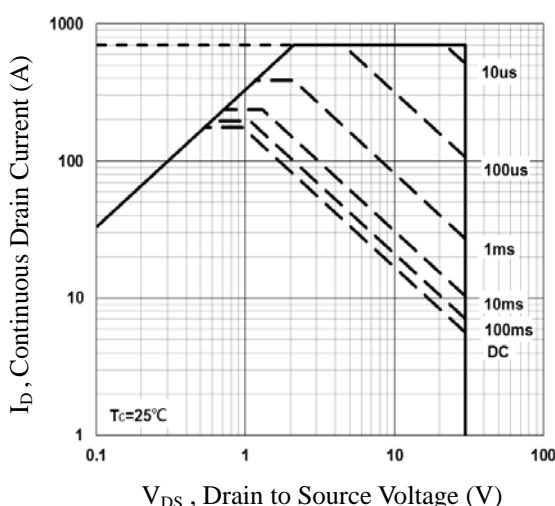


Fig.6 Maximum Safe Operation Area

## 30V N-Channel MOSFETs

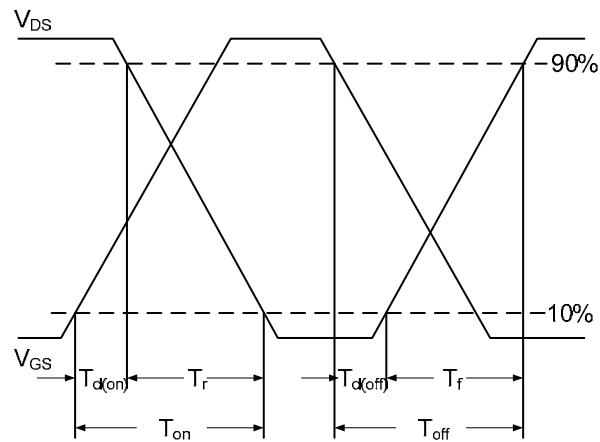


Fig.7 Switching Time Waveform

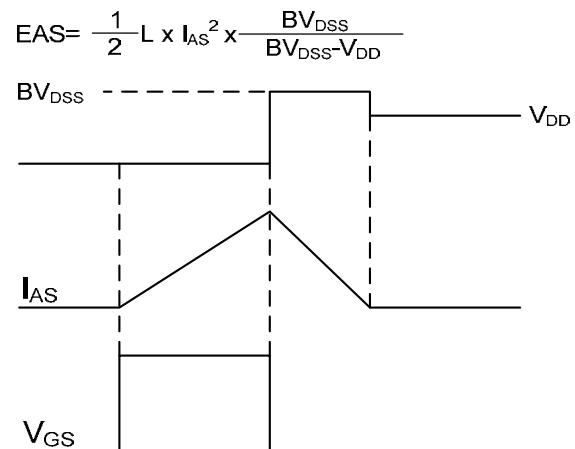


Fig.8 EAS Waveform

30V N-Channel MOSFETs

## TO-263 PACKAGE INFORMATION

